

## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

IN RE APPLICATION OF: Setho Sing Fee et al.

APPLICATION NO.:

09/944,246

FILED:

30 August 2001

FOR: PACKAGED MICROELECTRONIC

**DEVICES AND METHODS OF FORMING** 

SAME

EXAMINER: Tu-Tu Ho

**ART UNIT: 2818** 

CONF. No: 1798



PATENT.

## Amendment As Submission Under 37 C.F.R. § 1.114

Assistant Commissioner for Patents Washington, D.C. 20231

Sir:

The present communication is being filed as submission under 37 C.F.R. §1.114 in the above-identified application. Please amend the application as follows.

## In the Claims:

Following is a complete listing of the claims pending in the application, as amended:

 A method of assembling a stacked microelectronic device assembly, comprising: assembling a plurality of microelectronic device assemblies, each microelectronic device assembly being assembled by:

releasably attaching a support to a lead frame, the lead frame having a front surface, a back surface, a thickness, an opening passing through the thickness, and a plurality of lead fingers, the support having an exposed surface spanning the opening;

releasably attaching a back surface of a microelectronic device to the exposed surface of the support;

electrically coupling the microelectronic device to the lead frame;





## Perkins Coie LLP P.O. Box 1247

Seattle, Washington 98111-1247 Phone (206) 583-8888 Fax (206) 583-8500

Docket No.:

108298630US

Date:

March 11, 2003

application of:

Setho Sing Fee et al.

Application No.:

Filed: For:

Setho Sing Fee et al.

09/944,246 Confirmation No.: 1/70

August 30, 2001

PACKAGED MICROELECTRONIC DEVICES AND METHODS OF FORMING
SAME

DISSIONER FOR PATENTS

**BOX RCE** 

ASSISTANT COMMISSIONER FOR PATENTS

**WASHINGTON DC 20231** 

Sir:

Transmitted herewith is an Amendment As Submission Under 37 C.F.R. § 1.114 in the above-identified application.

Applicant claims small entity status. See 37 CFR 1.27.

Applicant has previously claimed small entity status. See 37 CFR 1.27.

A Petition for an Extension of Time for month is enclosed.

A General Authorization Under 37 C.F.R. § 1.136(a)(3) is enclosed.

No additional claim fee is required.

The fee has been calculated as shown.

	(Cal. 1)		(Cal 2)	(Cal 2)			
<b> </b>	(Col. 1)		(Col. 2)	(Col. 3)			
	CLAIMS						
	REMAINING		HIGHEST	PRESENT			
j	AFTER		PREV. PAID	EXTRA			
	AMENDMENT		FOR				
	*		**				
TOTAL	31	•	38	0			
	*		***				
IND.	4		6	0			
[ ] FIRST PRESENTATION OF MULT. DEP.							
CLAIMS							
EXTENSION OF TIME FEE							
TOTAL ADDITIONAL FEE							

SMALI	ENTITY	
RATE	ADDITIONAL FEE	OR
x 9	\$	
x 42	\$	
+130	\$	OR
	\$ \$	
	\$	TOT

	SMALL ENTITY					
	RATE	ADDITIONAL FEE				
	x 18	\$	0			
	x 84	\$	0			
	+260	\$	0			
•		\$ \$	0			
Γ.Α	T	\$	0			

OTHER THAN A

The "Highest Number Previously Paid For" (Total or Independent) is the highest number found from the equivalent box in Col. 1 of a prior amendment or the number of claims originally filed.

Please charge my Deposit Account No. 50-0665 in the amount of \$\_. A duplicate copy of this sheet is enclosed. A check in the amount of \$\\$ is attached.

The Commissioner is hereby authorized to charge payment of the following additional fees associated with this communication or credit any overpayment to Deposit Account No. 50-0665. A duplicate copy of this sheet is enclosed.

Any filing fees under 37 CFR 1.16 for the presentation of extra claims.

Any patent application processing fees under 37 CFR 1.17.

Respectfully submitted, PERKINS COIE LLP

Edward S. Hotchkiss Registration No. 33,904

<sup>\*</sup> If the entry in Col. 1 is less than the entry in Col. 2, write "0" in Col. 3.

If the "Highest Number Previously Paid For" IN THIS SPACE is less than 20, write "20" in this space.

If the "Highest Number Previously Paid For" IN THIS SPACE is less than 3, write "3" in this space.